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(54) **DISPLAY APPARATUS**

USPC 257/100, 40, 79, 642; 438/26, 99
See application file for complete search history.

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(65) **Prior Publication Data**

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(30) **Foreign Application Priority Data**

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(57) **ABSTRACT**

Provided is a display apparatus that is bendable. The display apparatus includes: a substrate including a display region that includes a plurality of light-emitting devices and an edge region that surrounds the display region; and a thin-film encapsulation layer on the display region and the edge region of the substrate. The thin-film encapsulation layer includes a plurality of inorganic films and at least one organic film disposed between the plurality of the inorganic films. At least one of the plurality of the inorganic films of the thin-film encapsulation layer includes inorganic patterns.

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H01L 21/00	(2006.01)
H01L 51/52	(2006.01)

(52) **U.S. Cl.**

CPC **H01L 51/5256** (2013.01)

(58) **Field of Classification Search**

CPC H01L 51/5256

19 Claims, 8 Drawing Sheets

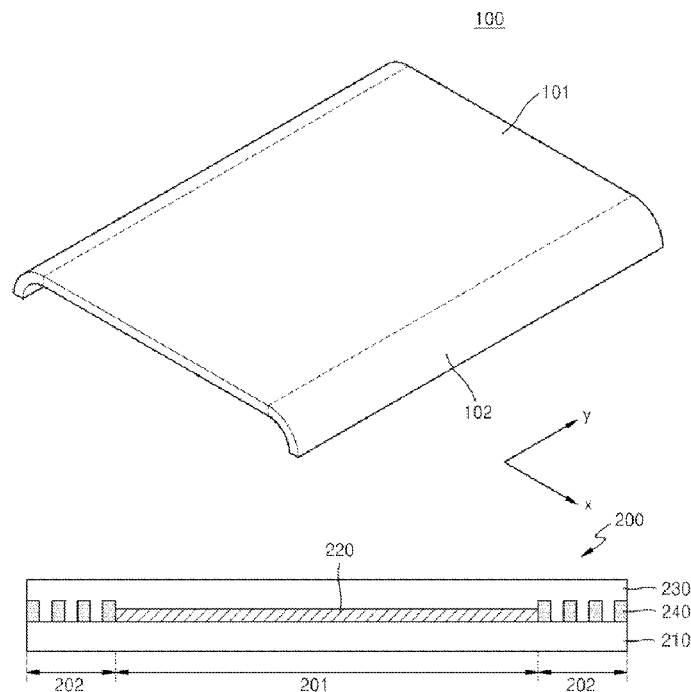


FIG. 1

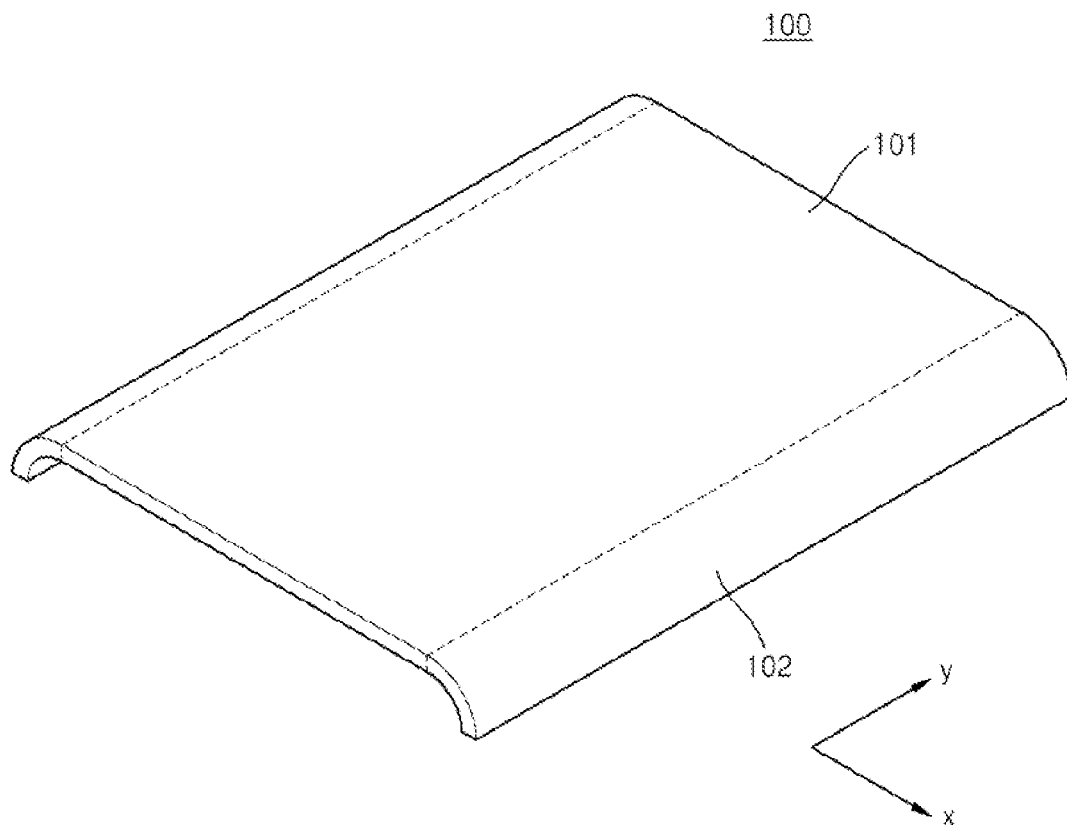


FIG. 2

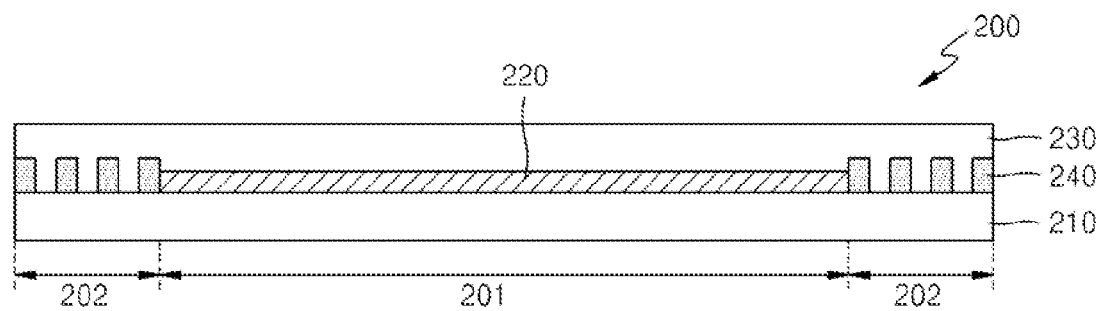


FIG. 3

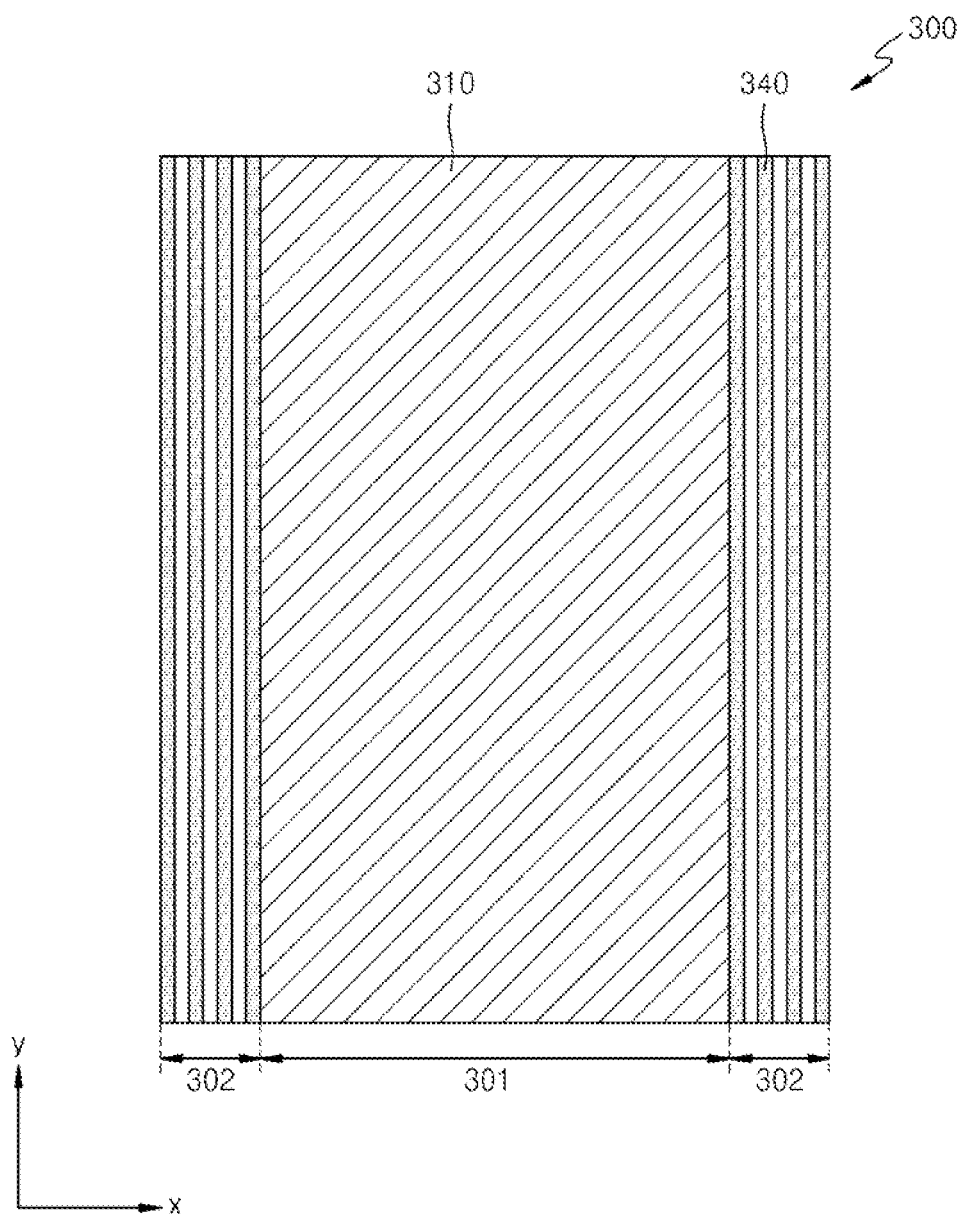


FIG. 4

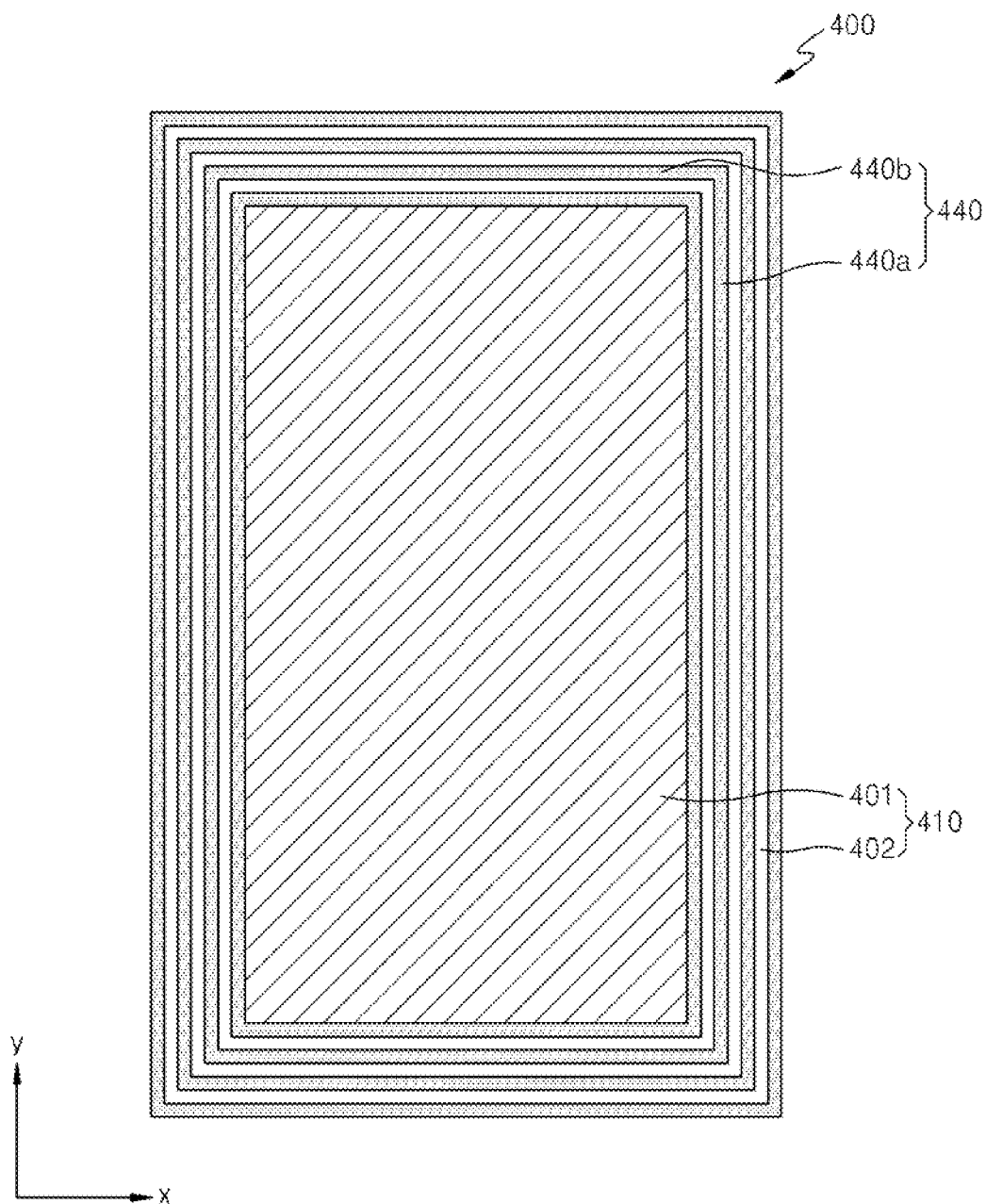


FIG. 5

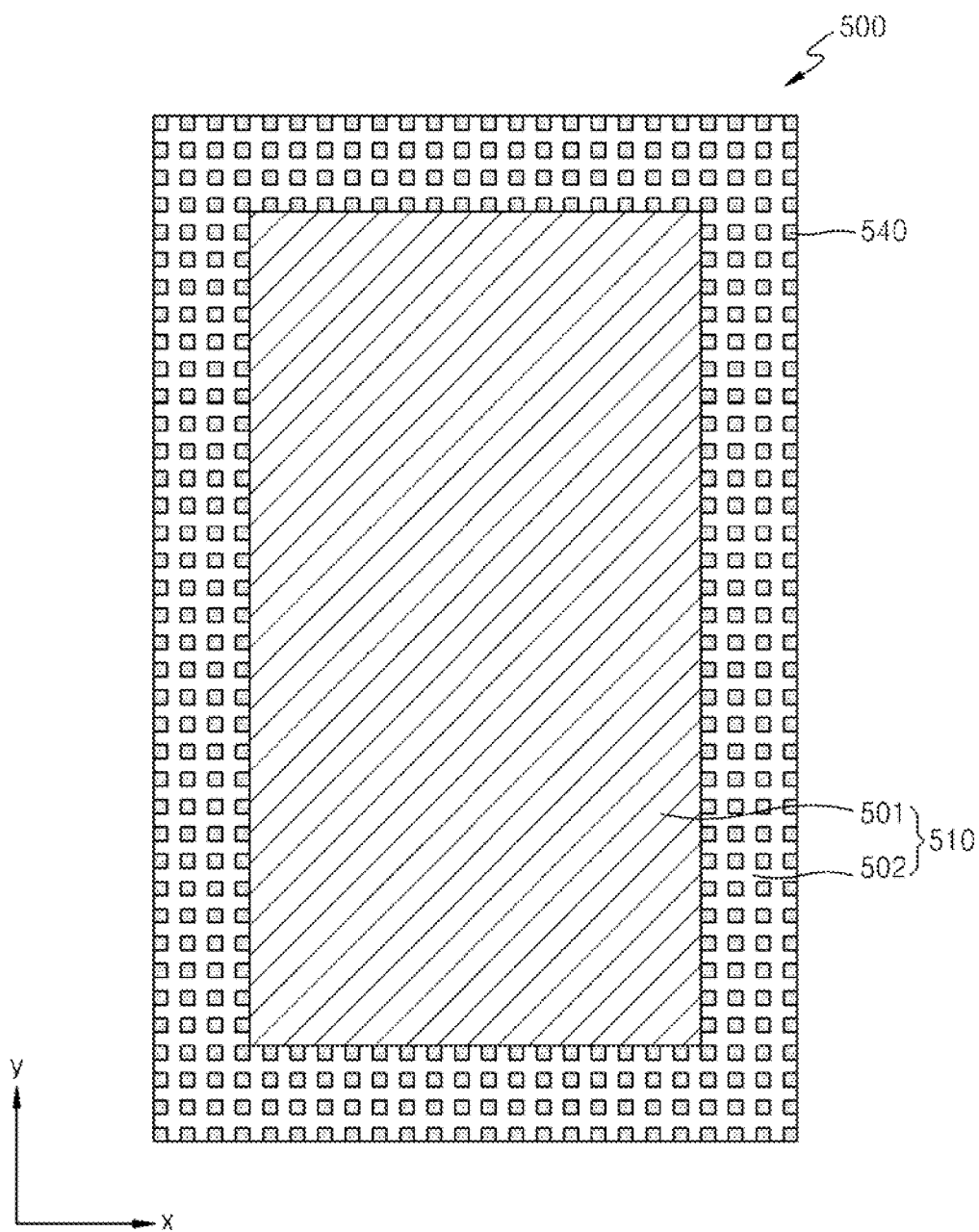


FIG. 6

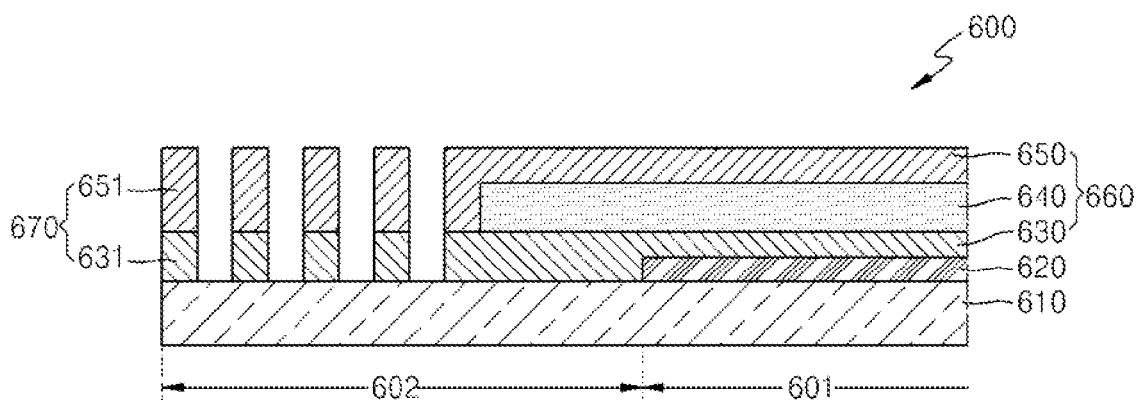


FIG. 7

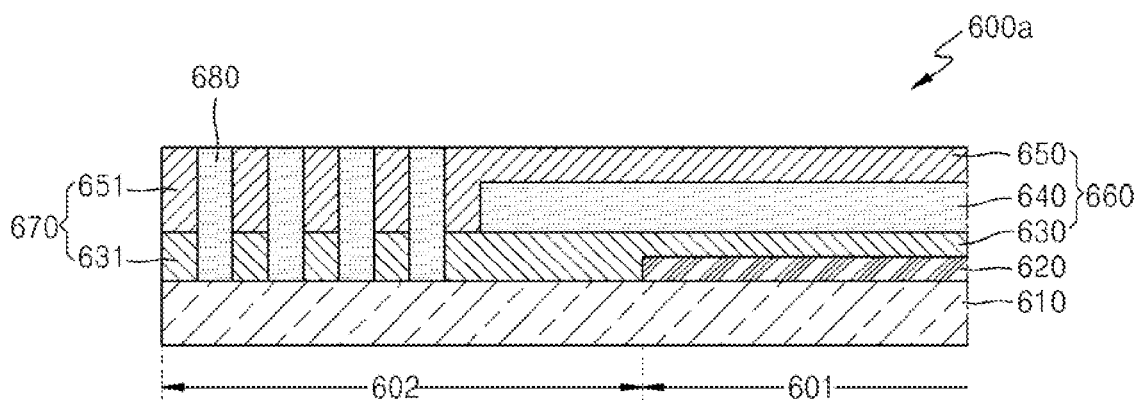


FIG. 8

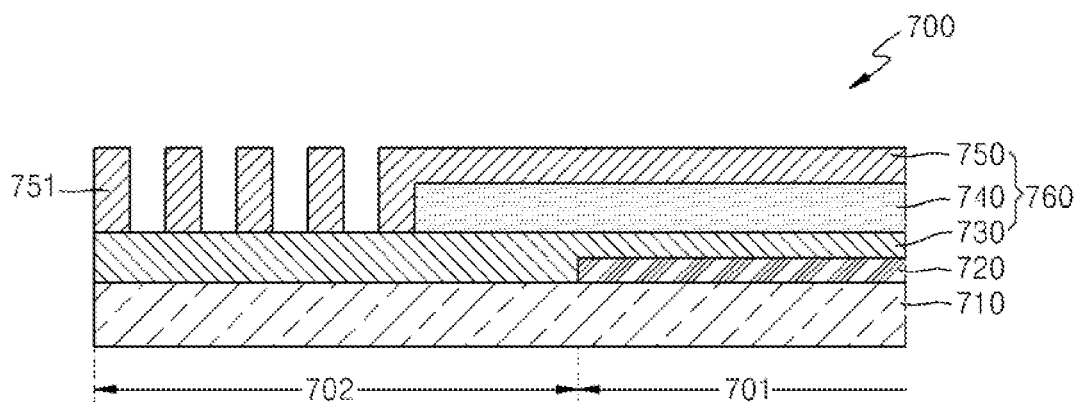


FIG. 9

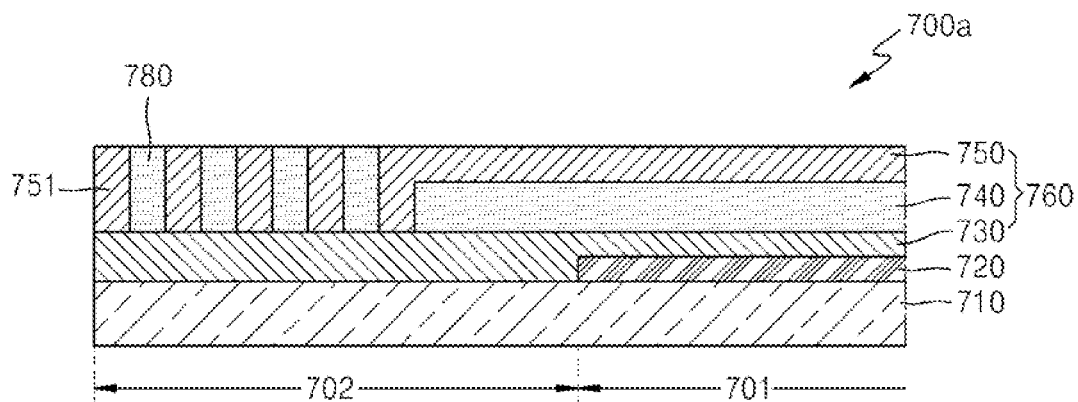


FIG. 10

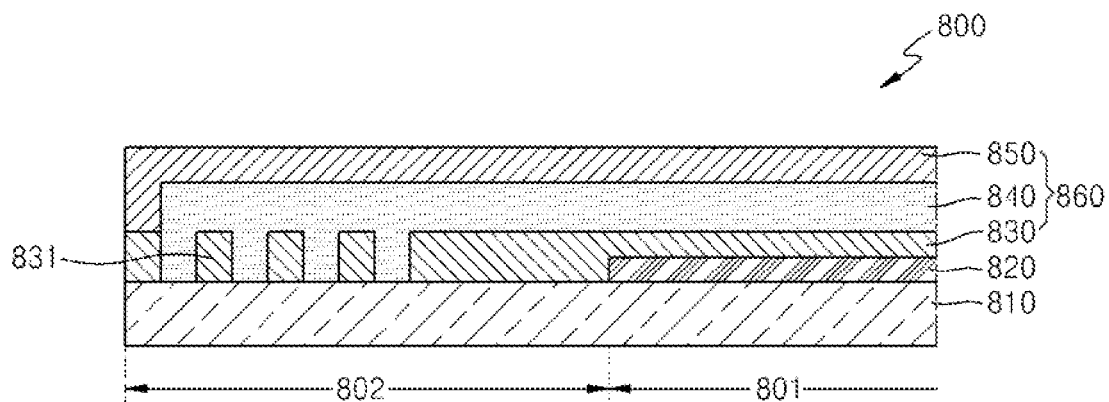


FIG. 11

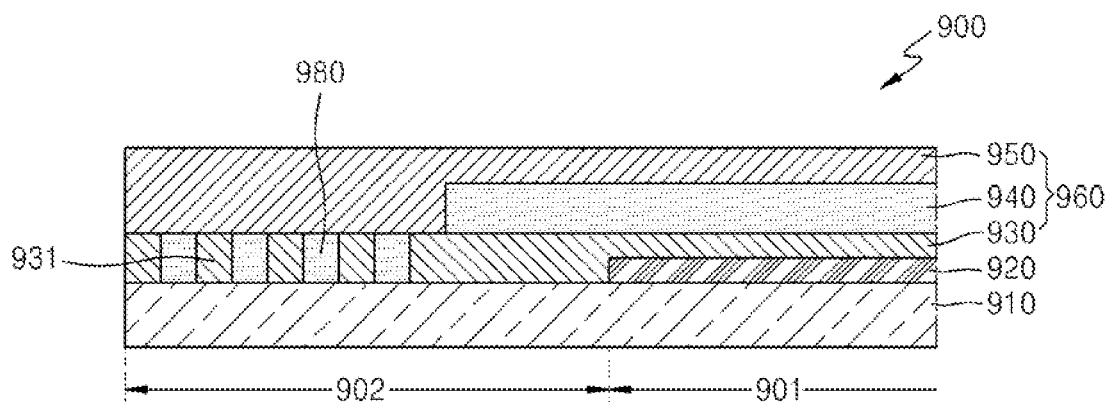
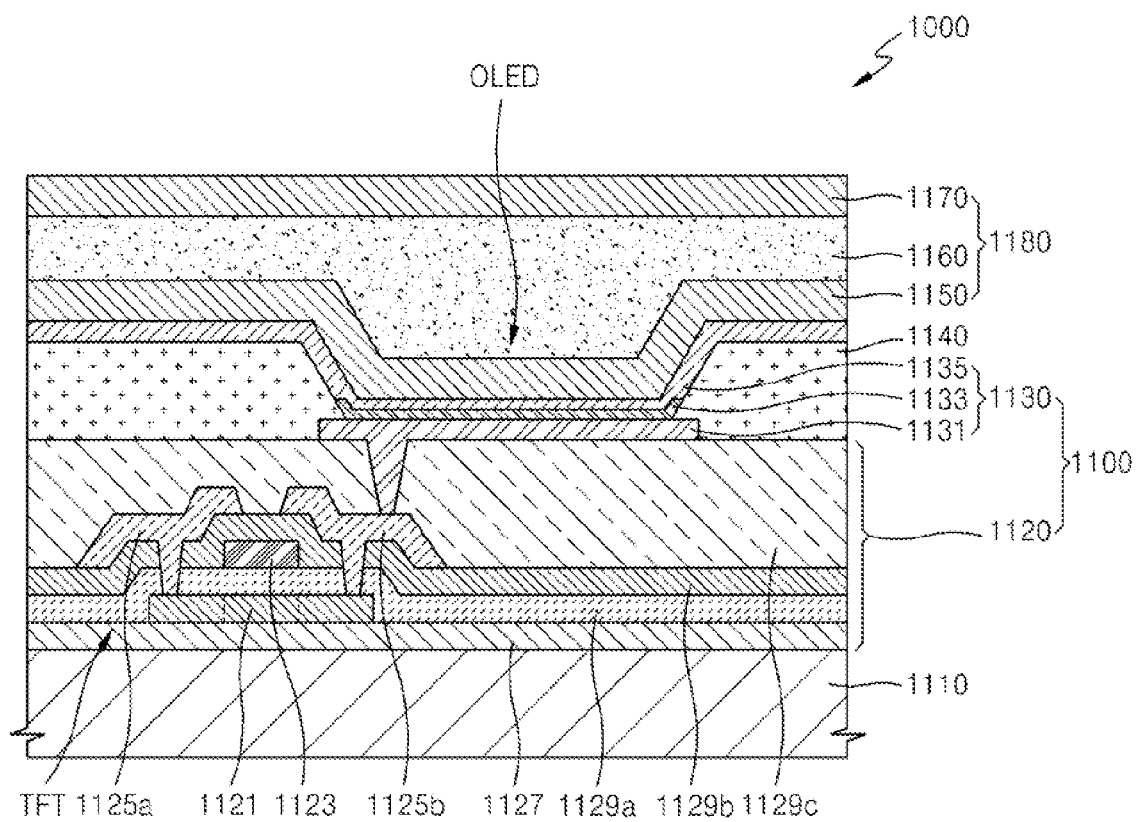


FIG. 12



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DISPLAY APPARATUS**CLAIM OF PRIORITY**

This application claims the benefit of Korean Patent Application No. 10-2013-0046210, filed on Apr. 25, 2013, in the Korean Intellectual Property Office, the disclosure of which is incorporated herein in its entirety by reference.

BACKGROUND OF THE INVENTION**1. Field of the Invention**

The present invention relates to a display apparatus, and more particularly, to a display apparatus having a bendable edge region.

2. Description of the Related Art

Recently, display apparatuses have emerged as important electronic products. Display apparatuses are being miniaturized for convenient portability. However, this miniaturization of display apparatuses is unable to satisfy all requirements of various consumers. Accordingly, display apparatuses including flexible panels are being actively researched and developed.

A flexible panel may be manufactured by forming display devices on a flexible substrate, and then forming a thin-film encapsulation layer for protecting the display devices from external moisture or oxygen. The thin-film encapsulation layer is generally formed by alternately stacking an organic film and an inorganic film. Here, when the flexible panel is bent, the inorganic film in the thin-film encapsulation layer may crack due to a stress. Accordingly, display apparatuses need to have a structure for relieving the stress applied to the inorganic films therein when being bent.

SUMMARY OF THE INVENTION

The present invention provides a display apparatus having a bendable edge region.

According to an aspect of the present invention, there is provided a display apparatus including: a substrate including a display region that includes a plurality of light-emitting devices, and an edge region that surrounds the display region; and a thin-film encapsulation layer disposed on the display region and the edge region of the substrate. The thin-film encapsulation layer includes a plurality of inorganic films and at least one organic film disposed between the plurality of the inorganic films. At least one of the plurality of the inorganic films includes inorganic patterns.

The inorganic patterns may be spaced apart from each other.

A portion of the display apparatus, on which the inorganic patterns are disposed, may be bendable.

The inorganic patterns may be located on the edge region.

The inorganic patterns may be partially formed on a portion of the edge region, and the display region may be disposed between the portions of the edge regions.

The inorganic patterns may be arranged in line patterns extending in a first direction and spaced apart from each other in a second direction perpendicular to the first direction, and the display region is disposed between the portions of the edge regions in the second direction.

The substrate may extend in first and second directions that are perpendicular to each other. The inorganic patterns may include first inorganic patterns between which the display region is disposed in the first direction, and second inorganic patterns between which the display region is disposed in the second direction. The first inorganic patterns may be arranged

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in line patterns extending in the second direction and spaced apart from each other in the first direction, and the second inorganic patterns may be arranged in line patterns extending in the first direction and spaced apart from each other in the second direction.

The inorganic patterns may be arranged in tile patterns.

The display apparatus may further include an organic material filling a space formed between the inorganic patterns spaced apart from each other.

The organic material is the same as a material of the at least one organic film.

The organic material may be different from a material of the at least one organic film.

The plurality of light-emitting devices may be organic light-emitting devices.

The substrate may be a flexible substrate.

According to another aspect of the present invention, there is provided a display apparatus including: a substrate including a display region and an edge region; a plurality of light-emitting devices formed on the display region of the substrate; a lower inorganic film disposed on the display region and the edge region to cover the plurality of light-emitting devices; an organic film disposed on the lower inorganic film to cover the display region; and an upper inorganic film disposed on the lower inorganic film and the organic film to cover the organic film, wherein at least one of the lower inorganic film and the upper inorganic film includes inorganic patterns formed on the edge region.

The inorganic patterns may be spaced apart from each other to expose a portion of the edge region, and include lower inorganic patterns and upper inorganic patterns corresponding to the lower inorganic patterns, and the lower inorganic film may include the lower inorganic patterns and the upper inorganic film may include the upper inorganic patterns.

The display apparatus may further include an organic material filling a gap between the inorganic patterns and extending to the portion of the edge region.

The lower inorganic film may continuously extend to cover the edge region, and the upper inorganic film may include the inorganic patterns spaced apart from each other to expose a portion of the lower inorganic film.

The display apparatus may further include an organic material filling a gap between the inorganic patterns and extending to the exposed portion of the lower inorganic film.

The lower inorganic film may include the inorganic patterns spaced apart from each other to expose a portion of the edge region, and the organic film may fill a gap between the inorganic patterns and extend to the portion of the edge region.

The lower inorganic film may include the inorganic patterns spaced apart from each other to expose a portion of the edge region, the display apparatus may further include an organic material filling a gap between the inorganic patterns and extending to the portion of the lower inorganic film, and the upper inorganic film may continuously extend to cover the inorganic patterns and the organic material.

The edge region may be bendable.

BRIEF DESCRIPTION OF THE DRAWINGS

The above and other features and advantages of the present invention will become more apparent by describing in detail exemplary embodiments thereof with reference to the attached drawings in which:

FIG. 1 is a schematic perspective view of a display apparatus according to an embodiment of the present invention;

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FIG. 2 is a schematic cross-sectional view of a display apparatus according to an embodiment of the present invention;

FIG. 3 is a schematic plan view of a display apparatus according to an embodiment of the present invention;

FIG. 4 is a schematic plan view of a display apparatus according to another embodiment of the present invention;

FIG. 5 is a schematic plan view of a display apparatus according to another embodiment of the present invention;

FIG. 6 is a schematic cross-sectional view of a portion of a display apparatus, according to an embodiment of the present invention;

FIG. 7 is a schematic cross-sectional view of a portion of a display apparatus, according to another embodiment of the present invention;

FIG. 8 is a schematic cross-sectional view of a portion of a display apparatus, according to another embodiment of the present invention;

FIG. 9 is a schematic cross-sectional view of a portion of a display apparatus, according to another embodiment of the present invention;

FIG. 10 is a schematic cross-sectional view of a portion of a display apparatus, according to another embodiment of the present invention;

FIG. 11 is a schematic cross-sectional view of a portion of a display apparatus, according to another embodiment of the present invention; and

FIG. 12 is a cross-sectional view of a display region of a display apparatus, according to an embodiment of the present invention.

DETAILED DESCRIPTION OF THE INVENTION

The invention now will be described more fully hereinafter with reference to the accompanying drawings, in which illustrative embodiments of the invention are shown. This invention may, however, be embodied in many different forms and should not be construed as limited to the embodiments set forth herein; rather, these embodiments are provided so that this disclosure will be thorough and complete, and will fully convey the scope of the invention to those of ordinary skill in the art.

In the drawings, like reference numerals denote like elements, and the sizes and thicknesses of layers and regions may be exaggerated or downscaled for clarity.

The terms used herein are for the purpose of describing particular embodiments only and are not intended to be limiting of the invention. As used herein, the singular forms “a”, “an” and “the” are intended to include the plural forms as well, unless the context clearly indicates otherwise. It will be further understood that the terms “comprises” and/or “comprising,” when used in this specification, specify the presence of stated features, integers, steps, operations, elements, and/or components, but do not preclude the presence or addition of one or more other features, integers, steps, operations, elements, components, and/or groups thereof. As used herein, the term “and/or” includes any and all combinations of one or more of the associated listed items. While such terms as “first,” “second,” etc., may be used to describe various components, such components must not be limited to the above terms. The above terms are used only to distinguish one component from another. Hereinafter, when a first feature is connected, is combined, or contacts a second feature, a third feature may be disposed between the first and second features. Also, when a first component is disposed on a second component, a third component may be disposed between the first and second components. However, if it is described that

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the first component is directly disposed on the second component, then the third component is not disposed between the first and second components.

Unless otherwise defined, all terms (including technical and scientific terms) used herein have the same meaning as commonly understood by one of ordinary skill in the art to which this invention belongs. It will be further understood that terms, such as those defined in commonly used dictionaries, should be interpreted as having a meaning that is consistent with their meaning in the context of the relevant art and will not be interpreted in an idealized or overly formal sense unless expressly so defined herein.

FIG. 1 is a schematic perspective view of a display apparatus **100** according to an embodiment of the present invention. Referring to FIG. 1, the display apparatus **100** includes a display region **101** that is flat and an edge region **102** that is bent.

The display region **101** may have an array of pixels, wherein the pixels may each include a thin-film transistor (TFT) and a light-emitting device controlled by the TFT. The light-emitting device may be an organic light-emitting device (OLED) that emits light by itself. The display region **101** may be referred to as a light-emitting region.

Alternatively, the pixels may each include a TFT and a liquid crystal layer controlled by the TFT, and a backlight may be disposed to overlap the display region **101**. The display region **101** may be referred to as an active region.

As shown in FIG. 1, the display region **101** may be flat. Alternatively, the display region **101** may be flexible. For example, the display region **101** may bend in a first direction, i.e., an x-axis direction, or in a second direction, i.e., a y-axis direction. The display region **101** may bend in any direction.

The edge region **102** may be disposed on both sides of the display region **101** in the first direction. Although not shown in FIG. 1, the edge region **102** may also be disposed on both sides of the display region **101** in the second direction.

The edge region **102** may include driving circuits or wires for driving the light-emitting devices of the display region **101**. The edge region **102** is a region where an image is not displayed, and thus may be referred to as a dead space region.

As shown in FIG. 1, the edge region **102** may bend in the first direction. The edge region **102** may bend in an angle equal to or larger than 90°. Moreover, the edge region **102** may become flat according to an external force. Also, the edge region **102** may bend in the second direction.

As the edge region **102** bends, a stress is applied to an inorganic film disposed in the edge region **102**, and thus the inorganic film may break due to the stress. In other words, the inorganic film may be cracked. According to an embodiment of the present invention, the inorganic film may have inorganic patterns that are spaced apart from each other so as to decrease the stress that causes the crack.

FIG. 2 is a schematic cross-sectional view of a display apparatus **200** according to an embodiment of the present invention. Referring to FIG. 2, the display apparatus **200** is bendable. Although the display apparatus **200** is shown to be flat, the display apparatus **200** may bend. Specifically, the display apparatus **200** may largely bend at a location where inorganic patterns **240** are disposed.

The display apparatus **200** includes a substrate **210**, a device layer **220** disposed on the substrate **210**, and a thin-film encapsulation layer **230** covering the substrate **210** and the device layer **220**. The thin-film encapsulation layer **230** includes the inorganic patterns **240**.

The substrate **210** may include a display region **201** where the device layer **220** is formed, and an edge region **202** where

the inorganic patterns **240** are disposed. The inorganic patterns **240** may be partially formed on a portion of the edge region.

The substrate **210** may be a flexible substrate. For example, the substrate **210** may be formed of plastic having excellent thermal resistance and durability, such as polyimide (PI), polyethylene terephthalate (PET), polyethylene naphthalate (PEN), polycarbonate (PC), polyarylate (PAR), polyetherimide (PEI), and polyethersulphone (PES). However, a material of the substrate **210** is not limited thereto, and any material having a flexible characteristic, such as a metal foil or thin glass, may be used to form the substrate **210**.

The device layer **220** may be disposed on the display region **201** of the substrate **210**. The device layer **220** may include TFTs and light-emitting devices connected to the TFTs. The device layer **220** may include a pixel array.

The thin-film encapsulation layer **230** may encapsulate the device layer **220** in order to prevent external moisture or oxygen from penetrating into the device layer **220**. The thin-film encapsulation layer **230** may be disposed on the substrate **210** to cover the device layer **220**.

The thin-film encapsulation layer **230** may include a plurality of inorganic films and at least one organic film disposed between the plurality of the inorganic films. In other words, the thin-film encapsulation layer **230** may be formed by alternately stacking inorganic films and organic films on the substrate **210** to cover the device layer **220**.

At least one of the inorganic films of the thin-film encapsulation layer **230** may include the inorganic patterns **240**. For example, when the thin-film encapsulation layer **230** has a stacked structure of a first inorganic film, a first organic film, a second inorganic film, a second organic film, and a third inorganic film on the substrate **210**, the first inorganic film may include the inorganic patterns **240**. In other words, the inorganic patterns **240** may be formed by patterning the first inorganic film. Alternatively, the second or third inorganic film may include the inorganic patterns **240**. Alternatively, a combination of the first and second inorganic films or a combination of the second and third inorganic films may include the inorganic patterns **240**. Alternatively, a combination of the first through third inorganic films may include the inorganic patterns **240**.

The inorganic films included in the thin-film encapsulation layer **230** may be a single or stacked film including a metal oxide or a metal nitride. In detail, the inorganic films may include any one of SiN_x , Al_2O_3 , SiO_2 , and TiO_2 .

The organic films included in the thin-film encapsulation layer **230** may be formed of a polymer, and may be a single or stacked film formed of any one of PET, PI, PC, epoxy, polyethylene, and polyacrylate. For example, the organic films may be formed of polyacrylate. In detail, the organic films may include a polymerized monomer composition including diacrylate-based monomer and triacrylate-based monomer. The polymerized monomer composition may further include a monoacrylate-based monomer. Alternatively, the polymerized monomer composition may further include a photoinitiator, such as TPO.

The inorganic patterns **240** may be disposed on the edge region **202** of the substrate **210**, or spaced apart from each other on a same plane as shown in FIG. 2. A gap between the inorganic patterns **240**, which are spaced apart from each other, may be filled with an organic material. The organic material filling the gap may be the same as a material of the organic film included in the thin-film encapsulation layer **230**. Alternatively, the organic material may be different from the material of the organic film included in the thin-film encapsulation layer **230**. The organic material may be a flexible

material, and the material of the organic film included in the thin-film encapsulation layer **230** may have high strength and high sealability.

The organic material may absorb a stress applied to the inorganic patterns **240** when the display apparatus **200** bends. Accordingly, even when the edge region **202** is largely bent, the inorganic patterns **240** may not crack. Alternatively, the gap between the inorganic patterns **240** may be an air gap.

FIG. 3 is a schematic plan view of a display apparatus **300** according to an embodiment of the present invention. Referring to FIG. 3, the display apparatus **300** is bendable. Although the display apparatus **300** is shown to be flat in FIG. 3, the display apparatus **300** may bend. Specifically, the display apparatus **300** may largely bend in an edge region **302** where inorganic patterns **340** are disposed.

The display apparatus **300** includes a substrate **310** that includes a display region **301** and the edge region **302**, and the inorganic patterns **340** disposed on the edge region **302**. The substrate **310** may extend in a first direction, i.e., an x-axis direction, and a second direction, i.e., a y-axis direction. The substrate **310** may be a flexible substrate.

Light-emitting devices may be formed in the display region **301**. The display region **301** may be flat. Alternatively, the display region **301** may be also bendable.

The edge region **302** may be disposed on both sides of the display region **301** in the first direction. Although not shown in FIG. 3, the edge region **302** may also be disposed on both sides of the display region **301** in the second direction. The inorganic patterns **340** may be disposed in the edge region **302**, and the edge region **302** may bend based on an axis extending in the second direction.

As shown in FIG. 3, the inorganic patterns **340** may have line patterns that are spaced apart from each other in the first direction and extending in the second direction. In FIG. 3, a thickness of the inorganic patterns **340** is similar to a width of a gap between the inorganic patterns **340**, but alternatively, the thickness of the inorganic patterns **340** may be larger than the width of the gap. Alternatively, the thickness of the inorganic patterns **340** may be smaller than the width of the gap. The gap between the inorganic patterns **340** may be filled by an organic material.

Alternatively, the inorganic patterns **340** may have tile patterns in which patterns of certain shapes are regularly arranged.

FIG. 4 is a schematic plan view of a display apparatus **400** according to another embodiment of the present invention. Referring to FIG. 4, the display apparatus **400** is bendable. Although the display apparatus **400** is shown to be flat in FIG. 4, the display apparatus **400** may bend. Specifically, the display apparatus **400** may largely bend in an edge region **402** where inorganic patterns **440** are disposed.

The display apparatus **400** includes a substrate **410** that includes a display region **401** and the edge region **402** that surrounds the display region **401**, and the inorganic patterns **440** disposed on the edge region **402**. Light-emitting devices may be formed in the display region **401**.

The edge region **402** may be disposed to surround the display region **401**. The inorganic patterns **440** may be disposed in the edge region **402**.

In detail, first inorganic patterns **440a** may be disposed in a first portion of the edge region **402** at both sides of the display region **401** in a first direction, i.e., an x-axis direction, wherein the first inorganic patterns **440a** may have line patterns that are spaced apart from each other in the first direction and extend in a second direction, i.e., a y-axis direction. The first portion of the edge region **402** may bend based on an axis extending in the second direction.

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Second inorganic patterns **440b** may be disposed in a second portion of the edge region **402** at both sides of the display region **401** in the second direction, wherein the second inorganic patterns **440b** may have line patterns that are spaced apart from each other in the second direction and extend in the first direction. The second portion of the edge region **402** may bend based on an axis extending in the first direction.

FIG. 5 is a schematic plan view of a display apparatus **500** according to another embodiment of the present invention. Referring to FIG. 5, the display apparatus **500** is bendable. Although the display apparatus **500** is shown to be flat in FIG. 5, the display apparatus **500** may bend.

The display apparatus **500** includes a substrate **510** having a display region **501** and an edge region **502** surrounding the display region **501**, and inorganic patterns **540** disposed in the edge region **502**. Light-emitting devices may be formed in the display region **501**.

The inorganic patterns **540** may be disposed in the edge region **502**. The inorganic patterns **540** may be arranged in tile patterns in which patterns of certain shapes are regularly arranged. In FIG. 5, the inorganic patterns **540** are arranged in tile patterns in which square patterns are regularly arranged, but alternatively, rectangular patterns may be regularly arranged.

FIG. 6 is a schematic cross-sectional view of a portion of a display apparatus **600**, according to an embodiment of the present invention. Referring to FIG. 6, the display apparatus **600** is bendable. Although the display apparatus **600** is shown to be flat in FIG. 6, the display apparatus **600** may bend.

The display apparatus **600** includes a substrate **610**, a device layer **620** disposed on the substrate **610**, and a thin-film encapsulation layer **660** covering the substrate **610** and the device layer **620**. The thin-film encapsulation layer **660** includes inorganic patterns **670**.

The substrate **610** may include a display region **601** in which the device layer **620** is formed, and an edge region **602** in which the inorganic patterns **670** are disposed.

The device layer **620** may include TFTs and light-emitting devices connected to the TFTs, and may include a pixel array.

The thin-film encapsulation layer **660** may encapsulate the device layer **620** so that external moisture and oxygen do not penetrate into the device layer **620**. The thin-film encapsulation layer **660** may include a plurality of inorganic films and at least one organic film disposed between the inorganic films. In FIG. 6, the thin-film encapsulation layer **660** includes a lower inorganic film **630**, an organic film **640**, and an upper inorganic film **650**, but alternatively, the thin-film encapsulation layer **660** may include more numbers of organic films and inorganic films. Also, an uppermost layer of the thin-film encapsulation layer **660**, which is externally exposed, is an inorganic film in FIG. 6, but may alternatively be an organic film.

The lower inorganic film **630** may be disposed to completely cover the device layer **620** disposed on the substrate **610**. The lower inorganic film **630** may include lower inorganic patterns **631** formed on the edge region **602**. The lower inorganic film **630** may be a single or stacked film including a metal oxide or a metal nitride, and may include any one of SiN_x , Al_2O_3 , SiO_2 , and TiO_2 .

Although not shown in FIG. 6, a halogenated metal layer including lithium fluoride (LiF) may be disposed between the device layer **620** and the lower inorganic film **630**. The halogenated metal layer may prevent the device layer **620** from being damaged when the lower inorganic film **630** is formed via a sputtering method or a plasma deposition method.

The organic film **640** may be disposed on the lower inorganic film **630** to cover the device layer **620**. As shown in FIG.

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6, the organic film **640** may be disposed on a portion of the lower inorganic film **630**. The organic film **640** may be disposed to completely cover the display region **601**, and may be disposed to cover a portion of the edge region **602**. The organic film **640** may be formed of a polymer, and may be a single or stacked film including any one of PET, PI, PC, epoxy, polyethylene, and polyacrylate. For example, the organic film **640** may be formed of polyacrylate, and in detail, may include a polymerized monomer composition including a diacrylate-based monomer and a triacrylate-based monomer.

The upper inorganic film **650** may be disposed to completely cover the organic film **640**. The upper inorganic film **650** may include upper inorganic patterns **651** formed on the edge region **602**. The upper inorganic film **650** may be a single or stacked film including a metal oxide or a metal nitride, and may include any one of SiN_x , Al_2O_3 , SiO_2 , and TiO_2 . The upper inorganic film **650** and the lower inorganic film **630** may be formed of a same inorganic material. Alternatively, the upper inorganic film **650** and the lower inorganic film **630** may be formed of different inorganic materials.

The thin-film encapsulation layer **660** may include the inorganic patterns **670**, wherein the inorganic patterns **670** may include the lower inorganic patterns **631** and the upper inorganic patterns **651**. The inorganic patterns **670** may be formed by patterning portions on the edge region **602** where the lower and upper inorganic films **630** and **650** are directly stacked to expose the substrate **610**.

A portion of the edge region **602** of the substrate **610** may be exposed by a gap between the inorganic patterns **670**, and the gap may be an air gap.

FIG. 7 is a schematic cross-sectional view of a portion of a display apparatus **600a**, according to another embodiment of the present invention. FIG. 7 shows the display apparatus **600a** that is modified from the display apparatus **600** of FIG. 6. Thus, details about the display apparatus **600** may also be applied to details about the display apparatus **600a**.

The display apparatus **600a** may further include an organic material **680** filled in the gap between the inorganic patterns **670**. The organic material **680** may extend to a top surface of the substrate **610**. The organic material **680** may be formed of a same material as the organic film **640**. Alternatively, the organic material **680** may be formed of a different material from the organic film **640**.

FIG. 8 is a schematic cross-sectional view of a portion of a display apparatus **700**, according to another embodiment of the present invention. Referring to FIG. 8, the display apparatus **700** is bendable. Although the display apparatus **700** is shown to be flat in FIG. 8, the display apparatus **700** may bend.

The display apparatus **700** includes a substrate **710**, a device layer **720** disposed on the substrate **710**, and a thin-film encapsulation layer **760** covering the substrate **710** and the device layer **720**. The thin-film encapsulation layer **760** includes inorganic patterns **751**.

The substrate **710** may include a display region **701** in which the device layer **720** is formed, and an edge region **702** in which the inorganic patterns **751** are disposed.

The thin-film encapsulation layer **760** is similar to the thin-film encapsulation layer **660** of FIG. 6, and thus details about the thin-film encapsulation layer **660** may be applied to details about the thin-film encapsulation layer **760**. Only elements of the thin-film encapsulation layer **760** that are different from the thin-film encapsulation layer **660** will now be described.

As shown in FIG. 8, the thin-film encapsulation layer **760** may include a lower inorganic film **730**, an organic film **740**,

and an upper inorganic film 750. The lower inorganic film 730 may not only cover the device layer 720 formed on the substrate 710, but may also completely cover the substrate 710 including the edge region 702 of the substrate 710. The lower inorganic film 730 may be a continuous layer that is not patterned.

The organic film 740 may be disposed on a portion of the lower inorganic film 730 to cover the device layer 720. The organic film 740 may be disposed to completely cover the display region 701 and partially cover the edge region 702.

The upper inorganic film 750 may be disposed to completely cover the organic film 740. The upper inorganic film 750 may include the inorganic patterns 751 on the edge region 702. The inorganic patterns 751 may be formed by patterning the upper inorganic film 750 on the edge region 702 to expose the lower inorganic film 730.

A portion of the lower inorganic film 730 on the edge region 702 may be exposed by a gap between the inorganic patterns 751, and the gap may be an air gap.

FIG. 9 is a schematic cross-sectional view of a portion of a display apparatus 700a, according to another embodiment of the present invention. FIG. 9 shows the display apparatus 700a that is modified from the display apparatus 700 of FIG. 8. Thus, details about the display apparatus 700 may also be applied to details about the display apparatus 700a.

The display apparatus 700a may further include an organic material 780 filled in the gap between the inorganic patterns 751. The organic material 780 may extend to a top surface of the lower inorganic film 730. The organic material 780 may be formed of a same material as the organic film 740. Alternatively, the organic material 780 may be formed of a different material from the organic film 740.

FIG. 10 is a schematic cross-sectional view of a portion of a display apparatus 800, according to another embodiment of the present invention. Referring to FIG. 10, the display apparatus 800 is bendable. Although the display apparatus 800 is shown to be flat in FIG. 10, the display apparatus 800 may bend.

The display apparatus 800 includes a substrate 810, a device layer 820 disposed on the substrate 810, and a thin-film encapsulation layer 860 covering the substrate 810 and the device layer 820. The thin-film encapsulation layer 860 includes inorganic patterns 831.

The substrate 810 may include a display region 801 in which the device layer 820 is formed, and an edge region 802 in which the inorganic patterns 831 are disposed.

The thin-film encapsulation layer 860 is similar to the thin-film encapsulation layer 660 of FIG. 6, and thus details about the thin-film encapsulation layer 660 may be applied to details about the thin-film encapsulation layer 860. Only elements of the thin-film encapsulation layer 860 that are different from the thin-film encapsulation layer 660 will now be described.

As shown in FIG. 10, the thin-film encapsulation layer 860 may include a lower inorganic film 830, an organic film 840, and an upper inorganic film 850.

The lower inorganic film 830 may be disposed to completely cover the device layer 820 on the substrate 810. The lower inorganic film 830 may include the inorganic patterns 831 formed on the edge region 802. The inorganic patterns 831 may be formed by patterning the lower inorganic film 830 to expose a portion of the edge region 802.

The organic film 840 may be disposed on a portion of the lower inorganic film 830 to cover the device layer 820. A gap between the inorganic patterns 831 may be filled with the organic film 840. The organic film 840 may extend to a top surface of the substrate 810. The organic film 840 may com-

pletely cover the display region 701 and to cover the inorganic patterns 831 on the edge region 802.

The upper inorganic film 850 may completely cover the organic film 840.

FIG. 11 is a schematic cross-sectional view of a portion of a display apparatus 900, according to another embodiment of the present invention. Referring to FIG. 11, the display apparatus 900 is bendable. Although the display apparatus 900 is shown to be flat in FIG. 11, the display apparatus 900 may bend.

The display apparatus 900 includes a substrate 910, a device layer 920 on the substrate 910, and a thin-film encapsulation layer 960 covering the substrate 910 and the device layer 920. The thin-film encapsulation layer 960 includes inorganic patterns 931.

The substrate 910 may include a display region 901 in which the device layer 920 is formed, and an edge region 902 in which the inorganic patterns 931 are disposed.

The thin-film encapsulation layer 960 is similar to the thin-film encapsulation layer 660 of FIG. 6, and thus details about the thin-film encapsulation layer 660 may be applied to details about the thin-film encapsulation layer 960. Only elements of the thin-film encapsulation layer 960 that are different from the thin-film encapsulation layer 660 will now be described.

As shown in FIG. 11, the thin-film encapsulation layer 960 may include a lower inorganic film 930, an organic film 940, and an upper inorganic film 950.

The lower inorganic film 930 may completely cover the device layer 920 on the substrate 910. The lower inorganic film 930 may include the inorganic patterns 931 on the edge region 902. The inorganic patterns 931 may be formed by patterning the lower inorganic film 930 to expose a portion of the edge region 902.

A gap between the inorganic patterns 931 may be filled by an organic material 980. The organic material 980 may extend to a top surface of the substrate 910 and have a top surface on a same level as a top surface of the inorganic patterns 931.

The organic film 940 may be disposed on a portion of the lower inorganic film 930 to cover the device layer 920. The organic film 940 may completely cover the display region 901 and partially cover the edge region 902. As shown in FIG. 11, the organic film 940 may not cover the organic material 980. Alternatively, the organic film 940 may cover at least a portion of the organic material 980.

The organic film 940 may be formed of a same material as the organic material 980. Alternatively, the organic film 940 may be formed of a different material from the organic material 980.

The upper inorganic film 950 may be disposed to completely cover the organic film 940. Also, the upper inorganic film 950 may completely cover the organic material 980 filled in the gap between the inorganic patterns 931.

FIG. 12 is a cross-sectional view of a display region of a display apparatus 1000, according to an embodiment of the present invention. In FIG. 12, the display apparatus 1000 may be an organic light-emitting display apparatus.

The display apparatus 1000 includes a substrate 1110, a device layer 1100 on the substrate 1110, and a thin-film encapsulation layer 1180 on the device layer 1100. The device layer 1100 includes an OLED layer 1130. The thin-film encapsulation layer 1180 may include a lower inorganic film 1150, an organic film 1160, and an upper inorganic film 1170, which are sequentially stacked on the substrate 1110.

The substrate 1110 may be a flexible substrate. The device layer 1100 may be disposed on the substrate 1110. Herein, the

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term device layer **1100** is used to refer to a layer including an OLED and a TFT for driving the OLED.

The device layer **1100** includes a plurality of pixels arranged in a matrix form. Each pixel includes an OLED and an electronic device electrically connected to the OLED. The electronic device may include at least two TFTs including a driving TFT and a switching TFT, and a storage capacitor. The electronic device may be electrically connected to wires, and may be driven by receiving an electric signal from a driving circuit outside the device layer **1100**. As such, an arrangement of the electronic device electrically connected to the OLED, and the wires is referred to as a TFT array.

The device layer **1100** includes a device/wire layer **1120** including the TFT array, and the OLED layer **1130** including an OLED array.

The device/wire layer **1120** may include a driving TFT for driving the OLED, a switching TFT, a capacitor, and wires connected to the driving and switching TFTs or the capacitor.

A buffer layer **1127** may be disposed on a top surface of the substrate **1110** to planarize the substrate **1110** and prevent impurities from penetrating into the substrate **1110**. The buffer layer **1127** may be formed of an inorganic insulating material.

An active layer **1121** may be disposed in a predetermined region on the buffer layer **1127**. The active layer **1121** may be formed by forming an inorganic or organic semiconductor, such as silicon or oxide semiconductor, on an entire surface of the substrate **1110** on the buffer layer **1127**, and then patterning the inorganic or organic semiconductor via a photolithography or etching process. When the active layer **1121** is formed of silicon, an amorphous silicon layer may be formed on the entire surface of the substrate **1110**, a polycrystalline silicon layer may be formed by crystallizing the amorphous silicon layer, and the polycrystalline silicon layer may be patterned and then impurities may be doped on adjacent regions to form the active layer **1121** including a source region, a drain region, and a channel region between the source and drain regions.

A gate insulating film **1129a** is disposed on the active layer **1121**. A gate electrode **1123** may be disposed in a predetermined region on the gate insulating film **1129a**. The gate electrode **1123** may be connected to a gate line (not shown) to which a control signal for controlling the TFT is applied. An interlayer insulating film **1129b** may be disposed on the gate electrode **1123**. The interlayer insulating film **1129b** includes a contact hole exposing the source and drain regions of the active layer **1121**, and a source electrode **1125a** and a drain electrode **1125b** may be respectively electrically connected to the source and drain regions of the active layer **1121** through the contact hole of the interlayer insulating film **1129b**. The TFT may be covered and protected by a passivation film **1129c**. The passivation film **1129c** may include an inorganic insulating film and/or an organic insulating film. The passivation film **1129c** may have a complex stacked structure of an inorganic insulating film and an organic insulating film.

The OLED may be disposed on the passivation film **1129c**.

The OLED layer **1130** may include a pixel electrode **1131** formed on the passivation film **1129c**, a counter electrode **1135** facing the pixel electrode **1131**, and an intermediate layer **1133** disposed between the pixel electrode **1131** and the counter electrode **1135**.

In a bottom-emission type organic light-emitting display apparatus, the pixel electrode **1131** is a transmissive electrode and the counter electrode **1135** is a reflective electrode. In a top-emission type organic light-emitting display apparatus, the pixel electrode **1131** is a reflective electrode and the counter electrode **1135** is a transmissive electrode. Hereinafter,

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the top-emission type organic light-emitting display apparatus, wherein the OLED emits light towards the thin-film encapsulation layer **1180**, will be described.

The pixel electrode **1131** may be a reflective electrode. The pixel electrode **1131** may have a stacked structure of a reflective layer and a transparent or translucent electrode layer having a high work function. The pixel electrode **1131** may operate as an anode.

A pixel-defining film **1140** that covers an edge of the pixel electrode **1131**, exposes a center of the pixel electrode **1131**, and has a predetermined opening may be disposed on the pixel electrode **1131**. The intermediate layer **1133** including an organic light-emitting layer may be disposed on a region limited by the opening.

The counter electrode **1135** may be a transmissive electrode. The counter electrode **1135** may be a semi-transmissive film wherein a metal having a low work function is thinly formed. In order to compensate for high resistance of a thin metal semi-transmissive film, a transparent conductive film formed of a transparent conductive oxide may be stacked on a metal semi-transmissive film. The counter electrode **1135** may be formed throughout the substrate **1110**, as a common electrode, and may operate as a cathode. Alternatively, polarities of the pixel electrode **1131** and the counter electrode **1135** may be switched around.

The intermediate layer **1133** may include an organic light-emitting layer that is formed of a low molecular organic material or a high molecular organic material. When the organic light-emitting layer is a low molecular organic layer formed of a low molecular organic material, a hole transport layer (HTL) and a hole injection layer (HIL) may be disposed in a direction of the pixel electrode **1131**, and an electron transport layer (ETL) and an electron injection layer (EIL) may be disposed in a direction of the counter electrode **1135** based on the organic light-emitting layer. On the other hand, when the organic light-emitting layer is a high molecular organic layer formed of a high molecular organic material, a HTL may be disposed in the direction of the pixel electrode **1131** based on the organic light-emitting layer.

In FIG. **12**, the OLED layer **1130** is disposed on the device/wire layer **1120** where the driving TFT is disposed, but alternatively, the pixel electrode **1131** of the OLED may be formed on a same layer as the active layer **1121** of the TFT, the pixel electrode **1131** may be disposed on a same layer as the gate electrode **1123** of the TFT, or the pixel electrode **1131** may be disposed on a same layer as the source and drain electrodes **1125a** and **1125b**.

Also, in FIG. **12**, the gate electrode **1123** of the driving TFT is disposed on the active layer **1121**, but alternatively, the gate electrode **1123** may be disposed below the active layer **1121**.

The thin-film encapsulation layer **1180** may be disposed on the substrate **1110** to cover the device layer **1100**. The OLED included in the device layer **1100** may be formed of an organic material, and thus may be easily deteriorated by external moisture or oxygen. Accordingly, the device layer **1100** is encapsulated to protect the device layer **1100**, and the thin-film encapsulation layer **1180** may have a stacked structure, wherein a plurality of organic materials and a plurality of inorganic materials are alternately stacked on each other, so as to encapsulate the device layer **1100**.

The thin-film encapsulation layer **1180** may include the lower inorganic film **1150**, the organic film **1160**, and the upper inorganic film **1170**, which are sequentially stacked. Alternatively, the thin-film encapsulation layer **1180** may have a structure, wherein at least three inorganic films and at

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least two organic films are alternately stacked. A lowermost or uppermost layer of the thin-film encapsulation layer **1180** may be an organic film.

The lower inorganic film **1150** and the upper inorganic film **1170** may be formed of an aluminum oxide, a silicon oxide, or a silicon nitride. The lower and upper inorganic films **1150** and **1170** may have a stacked structure of a plurality of inorganic insulating layers. The lower and upper inorganic films **1150** and **1170** may suppress external moisture and/or oxygen from penetrating into the OLED layer **1130**.

The organic film **1160** may be formed of a polymer organic compound. The organic film **1160** may relieve an internal stress of the lower and upper inorganic films **1150** and **1170**, or compensate for defects of and flatten the lower and upper inorganic films **1150** and **1170**.

According to the display apparatus of the present invention, by forming an inorganic film of a thin-film encapsulation layer on a bendable region to have a constant pattern, a stress due to bending may be relieved. Accordingly, the inorganic film of the thin-film encapsulation layer may be prevented from cracking, and a lifespan of the display apparatus may be increased.

While the present invention has been particularly shown and described with reference to exemplary embodiments thereof, it will be understood by those of ordinary skill in the art that various changes in form and details may be made therein without departing from the spirit and scope of the present invention as defined by the following claims.

What is claimed is:

1. A display apparatus, comprising:
 - a substrate comprising a display region that comprises a plurality of light-emitting devices, and an edge region that surrounds the display region; and
 - a thin-film encapsulation layer disposed on the display region and the edge region of the substrate, wherein the thin-film encapsulation layer comprises a plurality of inorganic films and at least one organic film disposed between the plurality of inorganic films, at least one of the plurality of the inorganic films including inorganic patterns that are spatially separated from each other.
2. The display apparatus of claim 1, wherein a portion of the display apparatus, on which the inorganic patterns are disposed, is bendable.
3. The display apparatus of claim 1, wherein the inorganic patterns are located on the edge region.
4. The display apparatus of claim 1, wherein the substrate extends in first and second directions that are perpendicular to each other, the inorganic patterns comprising:
 - first inorganic patterns, the display region being disposed between the first inorganic patterns in the first direction; and
 - second inorganic patterns, the display region being disposed between the second inorganic patterns in the second direction, the first inorganic patterns being arranged in line patterns extending in the second direction and spatially separated from each other in the first direction, the second inorganic patterns being arranged in line patterns extending in the first direction and spatially separated from each other in the second direction.
5. The display apparatus of claim 1, wherein the inorganic patterns are arranged in tile patterns.
6. The display apparatus of claim 1, wherein the plurality of light-emitting devices are organic light-emitting devices.
7. The display apparatus of claim 1, wherein the inorganic patterns are partially formed on portions of the edge region, and the display region is disposed between the portions of the edge regions.

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8. The display apparatus of claim 7, wherein the inorganic patterns are arranged in line patterns extending in a first direction and spatially separated from each other in a second direction perpendicular to the first direction, and the display region is disposed between the portions of the edge regions in the second direction.

9. The display apparatus of claim 1, further comprising an organic material filling a space formed between the inorganic patterns spatially separated from each other.

10. The display apparatus of claim 9, wherein the organic material is the same as a material of the at least one organic film.

11. The display apparatus of claim 9, wherein the organic material is different from a material of the at least one organic film.

12. A display apparatus comprising:

- a substrate comprising a display region and an edge region;
- a plurality of light-emitting devices formed on the display region of the substrate;
- a lower inorganic film disposed on the display region and the edge region to cover the plurality of light-emitting devices;
- an organic film disposed on the lower inorganic film to cover the display region; and
- an upper inorganic film disposed on the lower inorganic film and the organic film to cover the organic film, wherein at least one of the lower inorganic film and the upper inorganic film comprises inorganic patterns formed on the edge region, the inorganic patterns spatially separated from each other.

13. The display apparatus of claim 12, wherein the lower inorganic film comprises the inorganic patterns spatially separated from each other, a portion of the edge region is exposed through a gap formed between the inorganic patterns of the lower inorganic film, and the organic film fills the gap formed between the inorganic patterns of the lower inorganic film, the organic film covering the exposed portion of the edge region.

14. The display apparatus of claim 12, wherein the lower inorganic film comprises the inorganic patterns spatially separated from each other, a portion of the edge region being exposed through a gap formed between the inorganic patterns of the lower inorganic film,

- the display apparatus further comprises an organic material filling the gap formed between the inorganic patterns of the lower inorganic film, the organic material covering the exposed portion of the edge region, and
- the upper inorganic film completely covers the inorganic patterns and the organic material.

15. The display apparatus of claim 12, wherein the edge region is bendable.

16. The display apparatus of claim 12, wherein a portion of the edge region is exposed through a gap formed between the inorganic patterns, and the inorganic patterns comprise lower inorganic patterns and upper inorganic patterns formed on the lower inorganic patterns, the lower inorganic film comprising the lower inorganic patterns, the upper inorganic film comprising the upper inorganic patterns.

17. The display apparatus of claim 16, further comprising an organic material filling the gap formed between the inorganic patterns and covering the exposed portion of the edge region.

18. The display apparatus of claim 12, wherein the lower inorganic film continuously covers the edge region, and the upper inorganic film comprises the inorganic patterns spatially separated from each other, a portion of the lower inor-

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ganic film being exposed through a gap formed between the inorganic patterns of the upper inorganic film.

19. The display apparatus of claim **18**, further comprising an organic material filling the gap formed between the inorganic patterns of the upper inorganic film, and covering the exposed portion of the lower inorganic film.

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